

# SILICON TRANSISTOR 2SA1714

# PNP SILICON EPITAXIAL POWER TRANSISTOR (DARLINGTON CONNECTION) FOR HIGH-SPEED SWITCHING

The 2SA1714 is a high-speed darlington power transistor. This transistor is ideal for high-precision control such as PWM control for pulse mortors or blushless mortor of OA and FA equipment.

#### **FEATURES**

- · High DC current amplifiers due to darlington connection
- Large current capacitance and low VCE(sat)
- TO-126 power transistor with high power dissipation
- · Complementary transistor with 2SC4342

#### **QUALITY GRADES**

Standard

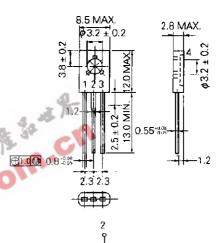
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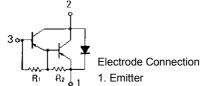
#### ABSOLUTE MAXIMUM RATINGS (Ta = 25°C)

Parameter	Symbol	Ratings	Unit
Collector to base voltage	Vcво	-100	٧
Collector to emitter voltage	VCEO	-100	٧
Emitter to base voltage	VEBO	-8.0	٧
Collector current (DC)	Ic(DC)	∓3.0	Α
Collector current (pulse)	IC(pulse)*	∓6.0	Α
Base current (DC)	I <sub>B(DC)</sub>	-0.3	Α
Total power dissipation	P⊤ (Ta = 25°C)	1.3	W
Total power dissipation	P <sub>T</sub> (Tc = 25°C)	12	W
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

<sup>\*</sup> PW  $\leq$  10 ms, duty cycle  $\leq$  50%

#### PACKAGE DRAWING (UNIT: mm)





 $\text{Ri} = 5.0 \text{ k}\Omega$  $R_2 = 0.7 \text{ k}\Omega$  2. Collector

3. Base

4. Fin (collector)

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## **ELECTRICAL CHARACTERISTICS (Ta = 25°C)**

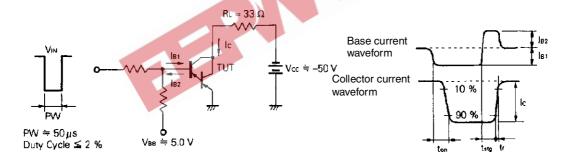
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Collector to emitter voltage	VCEO(SUS)	$I_{C} = -3.0 \text{ A}, I_{B} = -3.0 \text{ mA}, L = 1.0 \text{ mH}$	-100			٧
Collector cutoff current	Ісво	V <sub>CB</sub> = -100 V, I <sub>E</sub> = 0			-10	μΑ
Collector cutoff current	ICEO	VcE = -100 V, RBE = ∞			-10	μΑ
DC current gain	h <sub>FE1</sub> **	VcE = -2.0 V, Ic = -1.5 A	2,000		20,000	-
DC current gain	hFE2**	$V_{CE} = -2.0 \text{ V}, \text{ Ic} = -3.0 \text{ A}$	1,000			-
Collector saturation voltage	V <sub>CE(sat)</sub> **	$I_C = -1.5 \text{ A}, I_B = -1.5 \text{ mA}$		-0.9	-1.2	٧
Base saturation voltage	V <sub>BE(sat)</sub> **	$I_C = -1.5 \text{ A}, I_B = -1.5 \text{ mA}$		-1.5	-2.0	V
Turn-on time	ton	Ic = -1.5 A, I <sub>B1</sub> = -I <sub>B2</sub> = -1.5 mA, R <sub>L</sub> = 33 $\Omega$ , V <sub>CC</sub> $\cong$ -50 V Refer to the test circuit.		0.15		μs
Storage time	tstg			1.2		μs
Fall time	tf	nelei to the test circuit.		0.6		μs

<sup>\*\*</sup> Pulse test PW  $\leq$  350  $\mu$ s, duty cycle  $\leq$  2%/pulsed

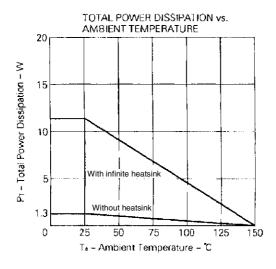
### **hfe CLASSIFICATION**

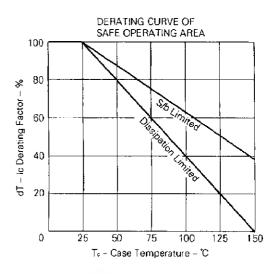
Marking	М	L	К
h <sub>FE1</sub>	2,000 to 5,000	4,000 to 10,000	8,000 to 20,000

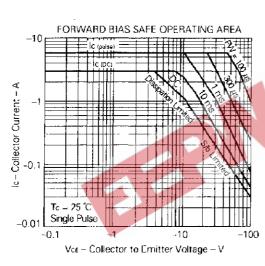
### SWITCHING TIME (ton, tstg, tf) TEST CIRCUIT

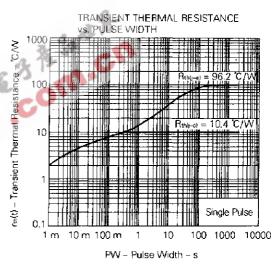


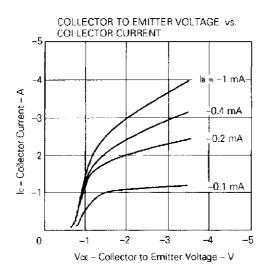
#### TYPICAL CHARACTERISTICS (Ta = 25°C)

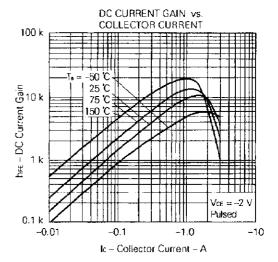




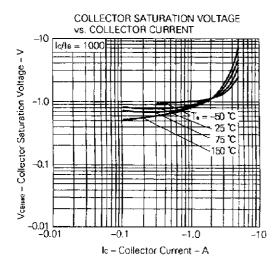


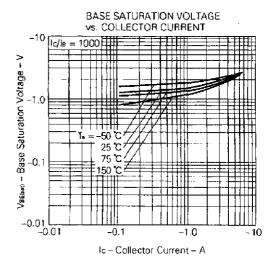


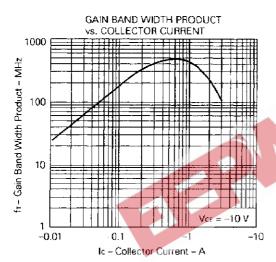


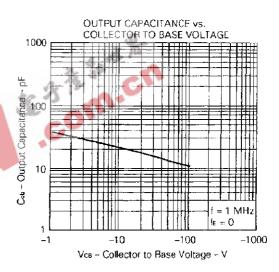


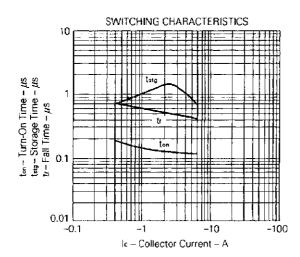
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